

COURSE PROSPECTUS

Name of the Group:*Product Engineering Group*

Name of the Course:*Advanced Diploma in Electronic Product Design*

Course Code:*PD 300*

Starting Date:*August 19, 2019*

Duration:*3 Months*

Course Coordinator:*Mr. Ishant Kumar Bajpai, Scientist/Engineer 'C'*
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Preamble:*Emergence of India as a global economy has opened up a huge demand for electronic products. National Policy on Electronics and Make in India initiative of Government of India has resulted in setting up of many industries in the Electronics Sector and has led to a huge demand for trained man power in Electronics System Design and Manufacture (ESDM).*

Objective of the Course:*To enable new electronics graduates/post graduates or working engineers in electronic industry; specify, design, develop and test electronic products. This course will bridge the major gap in competencies required to design, manufacture and market state-of-the art electronics products.*

Outcome of the Course:*On successful completion of the Course, the Participants shall*

- Be able to specify, Design, Develop and Test electronic Products.*
- Get exposure to Industrial Design of Electronic Products*

Course Structure:*This course consist of six modules. The modules are as follows:*

<i>PD 300</i>	<i>Module Name</i>	<i>Duration (Weeks)</i>
PD 301	Industrial Design of Electronic Products	2
PD 302	Electronic Circuit Design	3
PD 303	Electronic board design and bring up	4
PD 304	Project Work	3

Other Contents

a. **Course Fees:**

General Candidates: Course fee is Rs. 25,000/-+ GST at actuals

SC/ST Candidates: Tuition Fees are waived for SC/ST students admitted under SCSP/TSP. However they are required to remit an amount of **Rs. 8500/- as Advance caution/security deposit**. This amount will be considered as caution/security deposit and will be refunded after successful completion of the course. If the student fails to complete the course successfully this amount alongwith any other caution/security deposits by the student will be forfeited.

Modular wise Course Fee: Not applicable to this course

b. **Registration Fee:** An amount of Rs.1000/- (including GST)(nonrefundable) should be paid at the time of registering for the course.

This fee shall be considered as part of course fee, if the student joins the course. If a student register and pay for more than one course and join for any one course, all such amount will be adjusted against the course fee payable.

If the student does not join for the registered course / any of the registered courses, fee paid shall be forfeited.

For SC/ST candidates, the registration fee is Rs.500/- and will be considered as part of caution/security deposit and will be refunded after successful completion of the course. If the candidate does not join or fails to complete the course the amount will be forfeited

However above the registration fee shall be refunded on few special cases as given below

- Course postponed and new date is not convenient for the student
- Course cancelled in advance, well before the admission date

c. **Course Fee Installment Structure:** Students can pay the full fees of Rs. 29500/- (Rs. 25000/- + GST) in advance or as installments as given below

Fees	*Amount for General Candidates	Amount for SC/ST Candidates	Due Date (on or before)
Registration Fee	Rs.1000/-	Rs.500/-	During Registration
**Advance Fee	Rs. 10000/-	Rs. 8000/-	12/08/2019
Balance Fee	Rs. 18,500/-	Nil	19/08/2019
Total	Rs. 29,500/-	Rs. 8500/- (refundable after successful completion of course)	

*Above fees is inclusive GST @actuals(18%) and revision if any will be applicable at the time of payment.

** **Advance fee** - After publication of first selection list, the students in the first selection list have to pay the Advance Deposit within one week to take the provisional admission. Students in the additional selection list should pay both Advance and First installment fee together on or before counseling day

- d. **Eligibility:** M.E/M.Tech/BE/B.Tech(ECE/EEE/AEI/CSE/IT/Mechatronics/Bio medical and allied branches)
Or
M.Sc (Electronics/CS and allied branches).
- e. **Number of Seats :** 20
- f. **Selection of candidates :** Selection is based on the marks in qualifying degree
- g. **Test/Interview:** Not Applicable
- h. **Counseling/Admission :** 19/08/2019
- i. **Important Dates:**

<i>Last date for receiving completed application forms</i>	First selection list will be prepared based on the applications received on or before 07.08.2019. The additional selection list will be prepared based on the applications received on or before 13.08.2019, and excluding the applicants, included in the first selection list.
<i>Publication of first selection list in the Website http://calicut.nielit.gov.in/</i>	07.08.2019
<i>Last date for taking provisional admission by paying the advance fees (for applicants in the first selection list)</i>	12.08.2019
<i>Publication of additional selection list in our website (if there are vacant seats)</i>	13.08.2019
<i>Counseling date</i>	19.08.2019
<i>Class Commencement date</i>	19.08.2019
<i>Payment of Balance fee</i>	19.08.2019

- j. **Course Timings:** This program is a practical oriented one and hence there shall be more lab than theory classes. The classes and labs are from 9.30 am to 12.45

pm and 1.30 pm to 5.00 pm Monday to Friday. During project work, the timings are from 9.15 am to 5.15 pm. The theory to lab proportion is 30:70.

Internship: During the 6 months internship at Maker Village or any other industry of electronic sector, Students have to make their own arrangements for accommodation and food.

- k. **Placement** :We have a placement cell, which provides placement assistance to students who qualify our courses. The course improves the knowledge and skill of the students as it deals with the latest technologies and tools used in industries. This helps the student in getting a placement by
- Campus placement
 - Placement by companies for whom we send the students bio data and they conduct interviews at their site.
 - Students themselves attend interview at different companies and the course helps in the interview.
 - Based on the statistics from the past batches, approximately 50% students receive more than one internship offers and 100% students are placed in the core sector companies.
- l. **Lab Facilities:***CREO CAD Design tools, 3D Printer, PCB design tools such as OrCAD Capture, OrCAD PCB Layout Plus, PROTEUS VSM, Digital Storage Oscilloscopes, SMD soldering station, Power Harmonic Analyzer, High Precision Digital Multi meters, PCB Fab Lab, PCB Prototyping Machine, SMT Assembly setup (Stencil Printing, Pick & Place, Reflow oven etc), Thermal Imaging Camera, AC/DC Electronic Load; ARM Based development kits for IOT like Raspberry Pi, esp32, Network Protocol Analyzers,*

m. **Course Contents :**

PD 301: Industrial Design of Electronic Products (2 Weeks)

- **Product Development Process:** Product Planning, Product requirements and specifications, Concept development, Product Architecture, Project Management
- **Industrial Design:** Aesthetic, Ergonomic, Manufacturing, Cost, Thermal, EMI/EMC,
- **Quality and Testing:** DFMA, DFT, Prototyping, Patents & IPR, Product Development Economics, Quality Concepts, QFD, ISO9000, Reliability, DFMEA, Standards, certifications, regulatory compliance testing and Documentation

PD 302: Electronic Circuit Design (3 Weeks)

- **Electronics Fundamentals:** Material classification based on conductivity, basic Semi-conductor, Diodes, Characteristics of Diodes, Classification of

Diodes, Transistors, Classification of Transistors, BJT characteristics, JFET & MOSFET Characteristics, Transistor Amplification Circuits, OP Amp, Basic Characteristics of OP Amp, Feedback circuits, Introductions to Digital circuits.

- **Fundamentals of Circuit Design:** Basic circuit laws , Current & voltage division Rules, Introduction to Linear and Non-linear elements, Classification of sources, Equivalent Impedance Calculations in series & parallel circuits, Basic Network Theorems, Current, voltage and Power calculations in a circuit, Diode applications, Clipping and Clamping Circuits with Diodes, Rectifier Circuits, Transistors, Selection and analysis of Components, sensing devices and display devices.
- **Power Supply design:** Introduction to low power design techniques and methodologies. Introduction to various types of power supplies. Estimation of power supply requirements and power loss in electronic products. Selection of appropriate power supplies for the given primary power sources (230VAC/Battery). Design of power scheduler, power management unit of an electronic product.

PD: 303 Electronic Board Design and Bring up (4 Weeks)

- Evolution and Classification of Printed Circuit Boards, Challenges in Modern PCB, Design and Manufacturing, PCB fabrication, methodologies (SSB, DSB and multilayer board), PCB design considerations/ design rules for analog, digital and power applications, Electromagnetic interference in electronic systems and its impact Analysis of electronic circuit from noise emission point of view (both conducted and radiated emission) cross talk and reflection behaviour of the circuit in time domain, Thermal management of electronic devices and systems.
- **Semiconductor Packages:** Single chip packages or modules. (SCM) Commonly used packages and advanced packages; Materials in packages, Current trends in Packaging, Multichip modules (MCM) - types; System-in-package (SIP); Packaging roadmaps; Hybrid circuits.
- Introduction to high speed PCB design, Signal Integrity, Power Integrity and Thermal Analysis, Power distribution and noise, Signalling convention, terminations, Multilayer PCB design guide lines, Design of Multilayer PCB stackup, Differential pair routing, Length matching, Generation of different types of reports.

PD 304: Project (3 Weeks)

- Done as a group project where the trainees will be working on a real life problem sourced from industry/ start-ups and developing a complete product; right from identifying customer requirements and translating them into product specifications and realization of the product specifications through electronic, mechanical and industrial design within the cost and time constraints.

[Click here for General Terms and Conditions – Applicable to all courses](#)